

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
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EPAS ID: PAT4209577

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MASAHIKO MIYAUCHI	11/15/2016
YUICHI ISHIDA	11/15/2016
TOSHIO OGASAWARA	11/15/2016
RIKIO YOKOTA	11/15/2016
RECEIVING PARTY DATA	
Name:	KANEKA CORPORATION
Street Address:	2-3-18, NAKANOSHIMA, KITA-KU, OSAKA-SHI
City:	OSAKA
State/Country:	JAPAN
Postal Code:	530-8288
Name:	JAPAN AEROSPACE EXPLORATION AGENCY
Street Address:	7-44-1, JINDAIJIHIGASHIMACHI, CHOFU-SHI
City:	TOKYO
State/Country:	JAPAN
Postal Code:	1828522
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15310292
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	(908) 654-5000
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Correspondent Name:	LERNER, DAVID, LITTENBERG, KRUMHOLZ & MENTLIK, LLP
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Address Line 4:	WESTFIELD, NEW JERSEY 07090
ATTORNEY DOCKET NUMBER:	KANEKA 3.3F-009
NAME OF SUBMITTER:	MELINDA C. CORMIER

SIGNATURE:	/Melinda C. Cormier/
DATE SIGNED:	01/04/2017
Total Attachments: 4 source=Executed Assignment#page1.tif source=Executed Assignment#page2.tif source=Executed Assignment#page3.tif source=Executed Assignment#page4.tif	

ASSIGNMENT OF PATENT APPLICATION

Docket Number (Optional)

KANEKA 3.3F-009

WHEREAS, I, Masahiko Miyauchi of c/o Kaneka Corporation, 5-1-1, Torikainishi, Settsu-shi, Osaka 5660072 Japan, have invented or discovered inventions or discoveries, the subject matter of which is described in the patent application entitled "Varnish including 2-phenyl-4,4'-diaminodiphenyl ether, imide resin composition having excellent moldability, cured resin molded article having excellent breaking elongation, prepreg thereof, imide prepreg thereof, and fiber-reinforced material thereof having high heat resistance and excellent mechanical strength" (hereafter "Patent Application"),

☒ WHEREAS (if the left box is checked), the International Application was filed on April 20, 2015, as International Application Number PCT/JP2015/081968, and

☒ WHEREAS (if the left box is checked), the Patent Application names the following inventors: Masahiko Miyauchi, Yuichi Ishida, Toshio Ogasawara, and Rikio Yokota (and whereas I hereby authorize Lerner, David, Littenberg, Krumholz & Mentik, LLP, to insert in here in brackets [Application No. 15/310,292, filed on November 10, 2016] the application number and filing date of the application when known), and

WHEREAS, Kaneka Corporation, incorporated or otherwise formed in Japan and having a place of business at 2-3-18, Nakanoshima, Kita-ku, Osaka-shi, Osaka 5308286 Japan and Japan Aerospace Exploration Agency, incorporated or otherwise formed in Japan and having a place of business at 7-44-1, Jindaihiogashimachi, Chofu-shi, Tokyo 1628522 Japan (hereafter, the "assignee") is desirous of acquiring, or has acquired and is desirous of memorializing its acquisition further herein, the entire right, title and interest in same;

NOW, THEREFORE, for good and valuable consideration the receipt of which is hereby acknowledged, I agree as follows. I agree to assign, and hereby do assign, to the assignee my entire right, title and interest in and to the Assigned Applications in the United States of America and all other countries, where "Assigned Applications" means the Patent Application, including any and all inventions, discoveries and other subject matter described therein, any divisional, continuation, continuation-in-part, substitute, reissue, re-examination or other application claiming priority or benefit to the Patent Application pursuant to any law or treaty, and any patent issuing from the foregoing. I agree to assign, and hereby do assign, to assignee the right to claim such priority or benefit. I have not previously conveyed, nor am I aware of an obligation to convey, my rights in the Assigned Applications to a third party. I hereby authorize the U.S. Patent and Trademark Office, and any other governmental agency in the world, to issue to assignee all patents resulting from the Assigned Applications and to record assignee's ownership thereof. At assignee's reasonable request I agree, without further remuneration, to execute and deliver documents prepared at assignee's expense and to provide other cooperation, such as testimony, as may be reasonably required to evidence or protect assignee's rights in the Assigned Applications. Assignee may assign or transfer all or part of its rights set forth herein in its sole discretion. I agree that the assignee may affix its signature to this document as well as any other indicia of its acceptance of the provisions hereof. If any provision herein is unenforceable, the requirements of the provision shall remain to the full extent permissible by law and the offending portions thereof shall be deemed replaced, to the extent possible, with a provision most closely reflecting the purpose of the offending provision.

November 15, 2016

(Date)

Masahiko Miyauchi

Masahiko MIYAUCHI
(Signature)

N. Doi

Signature of Witness

Natsuki Doi

Printed Name of Witness

PATENT

REEL: 040840 FRAME: 0857

ASSIGNMENT OF PATENT APPLICATION

Docket Number (Optional)

KANEKA 3.3F-009

WHEREAS, I, Toshio Ogasawara of c/o Japan Aerospace Exploration Agency, 7-44-1, Jindaihiigashimachi, Chofu-shi, Tokyo 1828522, Japan, have invented or discovered inventions or discoveries, the subject matter of which is described in the patent application entitled "Varnish including 2-phenyl-4,4'-diaminodiphenyl ether, imide resin composition having excellent moldability, cured resin molded article having excellent breaking elongation, prepreg thereof, imide prepreg thereof, and fiber-reinforced material thereof having high heat resistance and excellent mechanical strength" (hereafter "Patent Application"),

☒ WHEREAS (if the left box is checked), the International Application was filed on April 20, 2015, as International Application Number PCT/JP2015/051988, and

☒ WHEREAS (if the left box is checked), the Patent Application names the following inventors: Masaniko Mitsuuchi, Yuichi Ishida, Toshio Ogasawara, and Rikio Yokota (and whereas I hereby authorize Lerner, David, Littenberg, Krumholz & Mentlik, LLP, to insert in here in brackets [Application No. 15/310,292, filed on November 10, 2016] the application number and filing date of the application when known), and

WHEREAS, Kaneka Corporation, incorporated or otherwise formed in Japan and having a place of business at 2-3-18, Nakanoshima, Kita-ku, Osaka-shi, Osaka 5300286, Japan and Japan Aerospace Exploration Agency, incorporated or otherwise formed in Japan and having a place of business at 7-44-1, Jindaihiigashimachi, Chofu-shi, Tokyo 1828522, Japan (hereafter, the "assignee") is desirous of acquiring, or has acquired and is desirous of memorializing its acquisition further herein, the entire right, title and interest in same;

NOW, THEREFORE, for good and valuable consideration the receipt of which is hereby acknowledged, I agree as follows. I agree to assign, and hereby do assign, to the assignee my entire right, title and interest in and to the Assigned Applications in the United States of America and all other countries, where "Assigned Applications" means the Patent Application, including any and all inventions, discoveries and other subject matter described therein, any divisional, continuation, continuation-in-part, substitute, reissue, re-examination or other application claiming priority or benefit to the Patent Application pursuant to any law or treaty, and any patent issuing from the foregoing. I agree to assign, and hereby do assign, to assignee the right to claim such priority or benefit. I have not previously conveyed, nor am I aware of an obligation to convey, my rights in the Assigned Applications to a third party. I hereby authorize the U.S. Patent and Trademark Office, and any other governmental agency in the world, to issue to assignee all patents resulting from the Assigned Applications and to record assignee's ownership thereof. At assignee's reasonable request I agree, without further remuneration, to execute and deliver documents prepared at assignee's expense and to provide other cooperation, such as testimony, as may be reasonably required to evidence or protect assignee's rights in the Assigned Applications. Assignee may assign or transfer all or part of its rights set forth herein in its sole discretion. I agree that the assignee may affix its signature to this document as well as any other indicia of its acceptance of the provisions hereof. If any provision herein is unenforceable, the requirements of the provision shall remain to the full extent permissible by law and the offending portions thereof shall be deemed replaced, to the extent possible, with a provision most closely reflecting the purpose of the offending provision.

November 15, 2016

(Date)

Toshio Ogasawara
Toshio OGASAWARA
(Signature)

M. Doi
Signature of Witness

Natsuki Doi
Printed Name of Witness

PATENT

REEL: 040840 FRAME: 0858

ASSIGNMENT OF PATENT APPLICATION

Docket Number (Optional)

KANEKA 3.3F-009

WHEREAS, I, Rikio Yokota of c/o Japan Aerospace Exploration Agency, 3-1-1, Yoshinodai, Chuo-ku, Sagami-hara-shi, Kanagawa 2525210 Japan, have invented or discovered inventions or discoveries, the subject matter of which is described in the patent application entitled "Varnish including 2-phenyl-4,4'-diaminodiphenyl ether, imide resin composition having excellent moldability, cured resin molded article having excellent breaking elongation, prepreg thereof, imide prepreg thereof, and fiber-reinforced material thereof having high heat resistance and excellent mechanical strength" (hereafter "Patent Application"),

☒ WHEREAS (if the left box is checked), the International Application was filed on April 20, 2016, as International Application Number PCT/JP2015/061958, and

☒ WHEREAS (if the left box is checked), the Patent Application names the following inventors: Masahiko Miyaochi, Yuichi Ishida, Toshiro Onosawara, and Rikio Yokota (and whereas I hereby authorize Lerner, David, Littenberg, Krumholz & Mentlik, LLP, to insert in here in brackets [Application No. 15/310,292, filed on November 10, 2016] the application number and filing date of the application when known), and

WHEREAS, Kaneka Corporation, incorporated or otherwise formed in Japan and having a place of business at 2-3-18, Nakano-shima, Kita-ku, Osaka-shi, Osaka 5308288 Japan and Japan Aerospace Exploration Agency, incorporated or otherwise formed in Japan and having a place of business at 7-44-1, Jindaihiigashimachi, Chofu-shi, Tokyo 1828522 Japan (hereafter, the "assignee") is desirous of acquiring, or has acquired and is desirous of memorializing its acquisition further herein, the entire right, title and interest in same;

NOW, THEREFORE, for good and valuable consideration the receipt of which is hereby acknowledged, I agree as follows. I agree to assign, and hereby do assign, to the assignee my entire right, title and interest in and to the Assigned Applications in the United States of America and all other countries, where "Assigned Applications" means the Patent Application, including any and all inventions, discoveries and other subject matter described therein, any divisional, continuation, continuation-in-part, substitute, reissue, re-examination or other application claiming priority or benefit to the Patent Application pursuant to any law or treaty, and any patent issuing from the foregoing. I agree to assign, and hereby do assign, to assignee the right to claim such priority or benefit. I have not previously conveyed, nor am I aware of an obligation to convey, my rights in the Assigned Applications to a third party. I hereby authorize the U.S. Patent and Trademark Office, and any other governmental agency in the world, to issue to assignee all patents resulting from the Assigned Applications and to record assignee's ownership thereof. At assignee's reasonable request I agree, without further remuneration, to execute and deliver documents prepared at assignee's expense and to provide other cooperation, such as testimony, as may be reasonably required to evidence or protect assignee's rights in the Assigned Applications. Assignee may assign or transfer all or part of its rights set forth herein in its sole discretion. I agree that the assignee may affix its signature to this document as well as any other indicia of its acceptance of the provisions hereof. If any provision herein is unenforceable, the requirements of the provision shall remain to the full extent permissible by law and the offending portions thereof shall be deemed replaced, to the extent possible, with a provision most closely reflecting the purpose of the offending provision.

November 15, 2016

(Date)

Rikio Yokota

Rikio YOKOTA
(Signature)

N. Doi

Signature of Witness

Natsuki Doi

Printed Name of Witness

PATENT

REEL: 040840 FRAME: 0859

ASSIGNMENT OF PATENT APPLICATION

Docket Number (Optional)

KANEKA 3.3F-009

WHEREAS, I, Yuichi Ishida of c/o Japan Aerospace Exploration Agency, 7-44-1, Jindaijigashimachi, Chofu-shi, Tokyo 1828522, Japan, have invented or discovered inventions or discoveries, the subject matter of which is described in the patent application entitled "Varnish including 2-phenyl-4,4'-diaminodiphenyl ether, imide resin composition having excellent moldability, cured resin molded article having excellent breaking elongation, prepreg thereof, imide prepreg thereof, and fiber-reinforced material thereof having high heat resistance and excellent mechanical strength" (hereafter "Patent Application"),

☒ WHEREAS (if the left box is checked), the International Application was filed on April 20, 2015, as International Application Number PCT/JP2015/061988, and

☒ WHEREAS (if the left box is checked), the Patent Application names the following inventors: Masahiko Miyasuchi, Yuichi Ishida, Toshio Ogasawara, and Rikio Yokota (and whereas I hereby authorize Lerner, David, Litteberg, Krumholz & Mentlik, LLP, to insert in here in brackets [Application No. 15/310,292, filed on November 19, 2016] the application number and filing date of the application when known), and

WHEREAS, Kaneka Corporation, incorporated or otherwise formed in Japan and having a place of business at 2-3-18, Nakagoshima, Kita-ku, Osaka-shi, Osaka 5308288 Japan and Japan Aerospace Exploration Agency, incorporated or otherwise formed in Japan and having a place of business at 7-44-1, Jindaijigashimachi, Chofu-shi, Tokyo 1828522, Japan (hereafter, the "assignee") is desirous of acquiring, or has acquired and is desirous of memorializing its acquisition further herein, the entire right, title and interest in same;

NOW, THEREFORE, for good and valuable consideration the receipt of which is hereby acknowledged, I agree as follows. I agree to assign, and hereby do assign, to the assignee my entire right, title and interest in and to the Assigned Applications in the United States of America and all other countries, where "Assigned Applications" means the Patent Application, including any and all inventions, discoveries and other subject matter described therein, any divisional, continuation, continuation-in-part, substitute, reissue, re-examination or other application claiming priority or benefit to the Patent Application pursuant to any law or treaty, and any patent issuing from the foregoing. I agree to assign, and hereby do assign, to assignee the right to claim such priority or benefit. I have not previously conveyed, nor am I aware of an obligation to convey, my rights in the Assigned Applications to a third party. I hereby authorize the U.S. Patent and Trademark Office, and any other governmental agency in the world, to issue to assignee all patents resulting from the Assigned Applications and to record assignee's ownership thereof. At assignee's reasonable request I agree, without further remuneration, to execute and deliver documents prepared at assignee's expense and to provide other cooperation, such as testimony, as may be reasonably required to evidence or protect assignee's rights in the Assigned Applications. Assignee may assign or transfer all or part of its rights set forth herein in its sole discretion. I agree that the assignee may affix its signature to this document as well as any other indicia of its acceptance of the provisions hereof. If any provision herein is unenforceable, the requirements of the provision shall remain to the full extent permissible by law and the offending portions thereof shall be deemed replaced, to the extent possible, with a provision most closely reflecting the purpose of the offending provision.

November 15, 2016

(Date)

Yuichi Ishida

Yuichi ISHIDA
(Signature)

N. Doi

Signature of Witness

Natsuki Doi

Printed Name of Witness

PATENT

RECORDED: 01/04/2017

REEL: 040840 FRAME: 0860